Switching Diode

Features

- SOD-123 Surface Mount Package
- High Breakdown Voltage
- Fast Speed Switching Time
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Continuous Reverse Voltage	V _R	100	V
Peak Forward Current	١ _F	200	mA
$\begin{array}{llllllllllllllllllllllllllllllllllll$	I _{FSM}	1.0 2.0	A
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-55 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board (Note 2) $T_A = 25^{\circ}C$	PD	425	mW
Derate above 25°C		3.4	mW/°C
Thermal Resistance Junction-to-Ambient	$R_{\theta JA}$	290	°C/W

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Typical Values

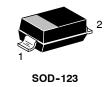
2. FR-5 = 1.0 oz Cu, 1.0 in^z pad



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1 CATHODE ANODE



CASE 425 STYLE 1

MARKING DIAGRAM



5I = Device Code

M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

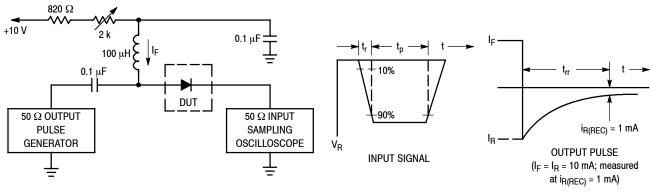
ORDERING INFORMATION

Device	Package	Shipping [†]
MMSD4148T1G	SOD-123 (Pb-Free)	3000 / Tape & Reel
MMSD4148T3G	SOD-123 (Pb-Free)	10,000 / Tape & Reel

† For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS		-		•
Reverse Breakdown Voltage ($I_{BR} = 100 \ \mu A$)	V _(BR)	100	-	V
Reverse Voltage Leakage Current $(V_R = 20 \text{ V})$ $(V_R = 75 \text{ V})$	Ι _R	-	25 5.0	nA μA
Forward Voltage (I _F = 10 mA)	V _F	-	1000	mV
Diode Capacitance (V _R = 0 V, f = 1.0 MHz)	C _D	-	4.0	pF
Reverse Recovery Time (I _F = I _R = 10 mA) (Figure 1)	t _{rr}	-	4.0	ns



1. A 2.0 k Ω variable resistor adjusted for a Forward Current (IF) of 10 mA.

2. Input pulse is adjusted so I_{R(peak)} is equal to 10 mA.

3. t_p » t_{rr}

Figure 1. Recovery Time Equivalent Test Circuit

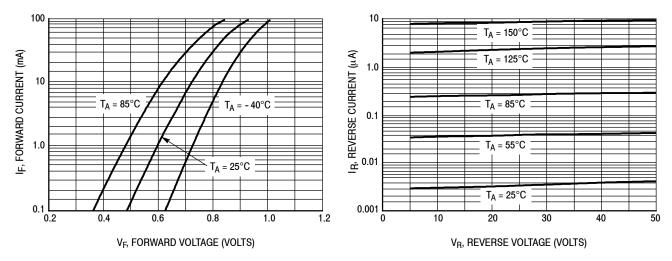


Figure 2. Forward Voltage

Figure 3. Leakage Current

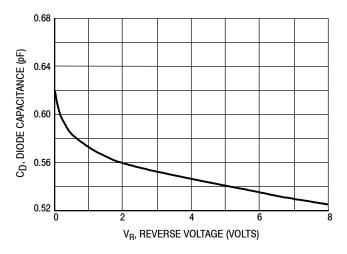
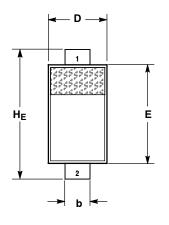
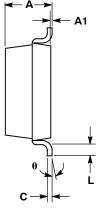


Figure 4. Capacitance

PACKAGE DIMENSIONS

SOD-123 CASE 425-04 ISSUE G





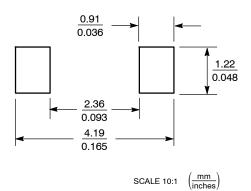
NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14 5M 1982

2. CONTROLLING DIMENSION: INCH.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.94	1.17	1.35	0.037	0.046	0.053
A1	0.00	0.05	0.10	0.000	0.002	0.004
b	0.51	0.61	0.71	0.020	0.024	0.028
С			0.15			0.006
D	1.40	1.60	1.80	0.055	0.063	0.071
Е	2.54	2.69	2.84	0.100	0.106	0.112
HE	3.56	3.68	3.86	0.140	0.145	0.152
L	0.25			0.010		
θ	0°		10°	0°		10°

STYLE 1: PIN 1. CATHODE 2. ANODE

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and

Mounting Techniques Reference Manual, SOLDERRM/D.

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